

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	243	(chip die) and (((carrier substrate) with flexible) same (metal metalization metallization)) and @pd>"20051202"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/27 13:05
L2	7	((chip die) and (((carrier substrate) with flexible) same (metal metalization metallization trace))). clm. and @pd>"20051202"	US-PGPUB	OR	ON	2006/03/27 13:25
L3	243	(chip die) and (((carrier substrate) with flexible) same (metal metalization metallization)) and @pd>"20051202"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/27 13:26
L4	243	(chip die) and (((carrier substrate) with flexible) same (metal metalization metallization)) and @pd>"20051202"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/27 13:36
L5	293	(chip die) and (((carrier substrate) with flexible) same (metal metalization metallization trace)) and @pd>"20051202"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/27 13:37
L6	86	(chip die) and (((carrier substrate) with flexible) same (trace)) and @pd>"20051202"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/27 14:02
L7	200	257/668,669,678,679,701,702,724. ccls. and @pd>"20051202"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/27 14:06
L8	219	438/107,123,125,612,666.ccls. and @pd>"20051202"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/27 14:09
S1	12	((("4151579") or ("6326233") or ("5888429") or ("5635751") or ("3691628") or ("6815251")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/02 09:28

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S2	1231	257/668.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 14:48
S3	364	257/668.ccls. and flexible	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 14:55
S4	104	257/669.ccls. and flexible	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 15:14
S5	992	257/678,679,701,702,724.ccls. and flexible	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 16:03
S6	1007	438/107,123,125,612,666.ccls. and flexible	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:08
S7	1153	438/107,123,125,612,666.ccls. and @pd>"20031126" not flexible	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/27 14:09
S8	1173	257/668,669,678,679,701,702,724.ccls. and @pd>"20031126" not flexible	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/27 14:05
S9	24092	(chip die) and ((carrier substrate) with flexible)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/02 09:28
S10	5039	(chip die) and (((carrier substrate) with flexible) same (metal metalization metallization trace))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/27 13:37
S12	1379	(chip die) and (((carrier substrate) with flexible) same (trace))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/27 14:02

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S13	4070	(chip die) and (((carrier substrate) with flexible) same (metal metalization metallization))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/27 13:36
S14	2486	(chip die) and (((carrier substrate) with flexible) same (metal metalization metallization)) and @pd<"20030603"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/27 13:25
S15	61	((chip die) and (((carrier substrate) with flexible) same (metal metalization metallization trace))). clm.	US-PGPUB	OR	ON	2006/03/27 13:25
S16	4071	(chip die) and (((carrier substrate) with flexible) same (metal metalization metallization)) and @pd<"20051202"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/24 13:47
S17	241	(chip die) and (((carrier substrate) with flexible) same (metal metalization metallization)) and @pd>"20051202"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/27 13:04

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